

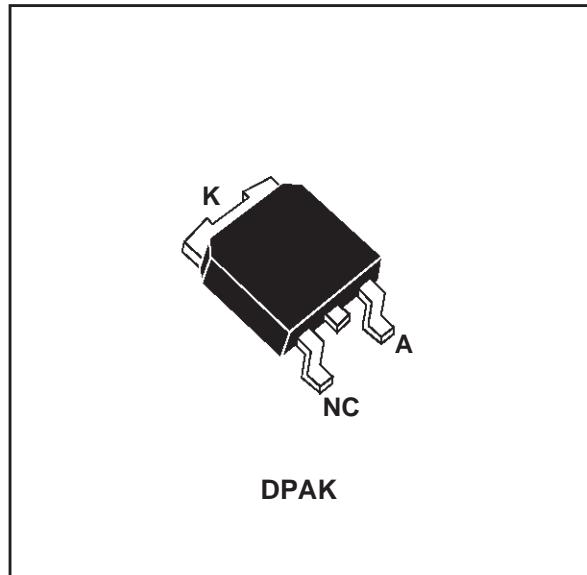
## TURBOSWITCH™ ULTRA-FAST HIGH VOLTAGE DIODE

### MAIN PRODUCT CHARACTERISTICS

|                      |        |
|----------------------|--------|
| $I_F(AV)$            | 3 A    |
| $V_{RRM}$            | 600 V  |
| $t_{rr}(\text{typ})$ | 20 ns  |
| $V_F(\text{max})$    | 1.65 V |

### FEATURES AND BENEFITS

- SPECIFIC TO FREEWHEEL MODE OPERATIONS: FREEWHEEL OR BOOSTER DIODE.
- ULTRA-FAST, AND SOFT RECOVERY.
- VERY LOW OVERALL POWER LOSSES IN BOTH THE DIODE AND THE COMPANION TRANSISTOR.
- HIGH FREQUENCY OPERATIONS.



### DESCRIPTION

The TURBOSWITCH is a very high performance series of ultra-fast high voltage power diodes. TURBOSWITCH family drastically cuts losses in both the diode and the associated switching IGBT or MOSFET in all freewheel mode operations and is particularly suitable and efficient in motor control

freewheel applications and in booster diode applications in Power Factor Control circuitries.

Packaged in DPAK, these 600V devices are particularly intended for use on 240V domestic mains.

### ABSOLUTE RATINGS (limiting values)

| Symbol            | Parameter                              |                        | Value         | Unit |
|-------------------|--|------------------------|---------------|------|
| $V_{RRM}$         | Repetitive peak reverse voltage        |                        | 600           | V    |
| $I_F(\text{RMS})$ | RMS forward current                    |                        | 6             | A    |
| $I_{FRM}$         | Repetitive peak forward current        | tp=5 µs F=5 kHz square | 20            | A    |
| $I_{FSM}$         | Surge non repetitive forward current   | tp=10 ms sinusoidal    | 35            | A    |
| $T_j$             | Maximum operating junction temperature |                        | 125           | °C   |
| $T_{stg}$         | Storage temperature range              |                        | - 65 to + 150 | °C   |

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### THERMAL AND POWER DATA

| Symbol                | Parameter  | Tests conditions   | Value | Unit |
|-----------------------|--|--|-------|------|
| R <sub>th</sub> (j-c) | Junction to case   |  | 6     | °C/W |
| P <sub>1</sub>        | Conduction power dissipation   | I <sub>F(AV)</sub> = 1.5A, δ = 0.5<br>T <sub>c</sub> = 110°C | 2.5   | W    |
| P <sub>max</sub>      | Total power dissipation<br>P <sub>max</sub> = P <sub>1</sub> + P <sub>3</sub> (P <sub>3</sub> = 10% P <sub>1</sub> ) | T <sub>c</sub> = 108°C                                       | 2.8   | W    |

### STATIC ELECTRICAL CHARACTERISTICS

| Symbol            | Parameter               | Tests conditions                      |   | Min. | Typ. | Max. | Unit |
|-------------------|-------------------------|---------------------------------------|---|------|------|------|------|
| V <sub>F</sub> ** | Forward voltage drop    | T <sub>j</sub> = 25°C                 | I <sub>F</sub> = 3 A                    |      |      | 1.85 | V    |
|                   |                         | T <sub>j</sub> = 125°C                | I <sub>F</sub> = 3 A                    |      | 1.3  | 1.65 |      |
| I <sub>R</sub> *  | Reverse leakage current | T <sub>j</sub> = 25°C                 | V <sub>R</sub> = 0.8 X V <sub>RRM</sub> |      |      | 20   | μA   |
|                   |                         | T <sub>j</sub> = 125°C                |   |      | 500  | 1200 |      |
| V <sub>to</sub>   | Threshold voltage       | I <sub>p</sub> < 3.I <sub>F(AV)</sub> | T <sub>j</sub> = 125°C                  |      |      | 1.15 | V    |
| R <sub>d</sub>    | Dynamic resistance      |                                       |   |      |      | 175  | mΩ   |

Test pulse : \* tp = 380 μs, δ < 2%

\*\* tp = 5 ms, δ < 2%

To evaluate the maximum conduction losses use the following equation :

$$P = V_{to} \times I_{F(AV)} + R_d \times I_F^2(RMS)$$

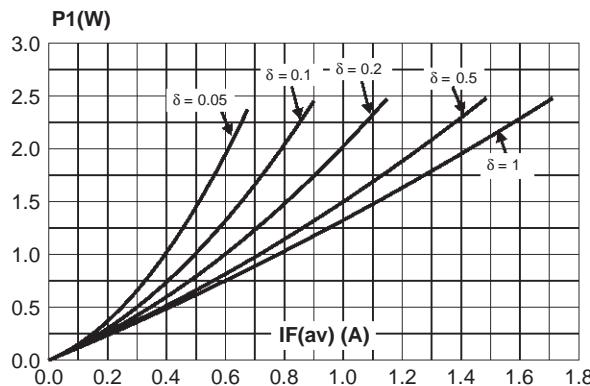
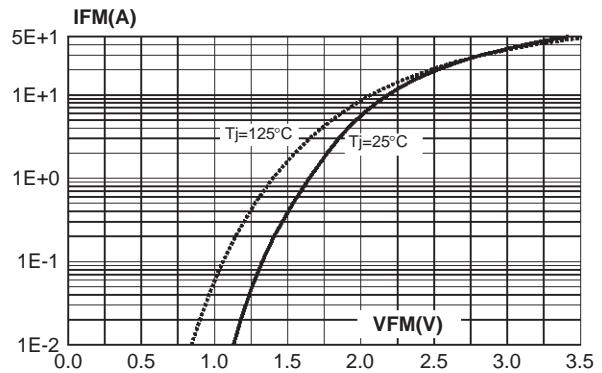
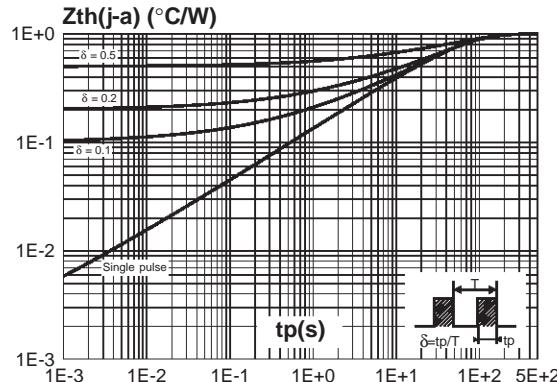
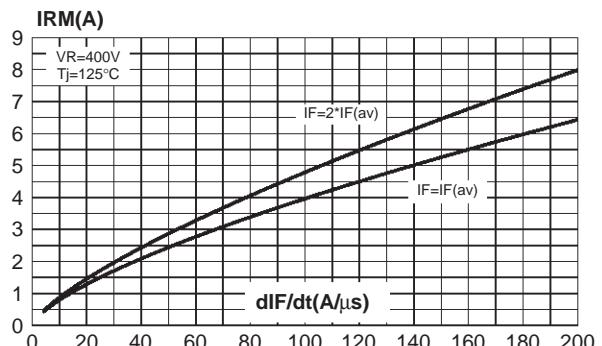
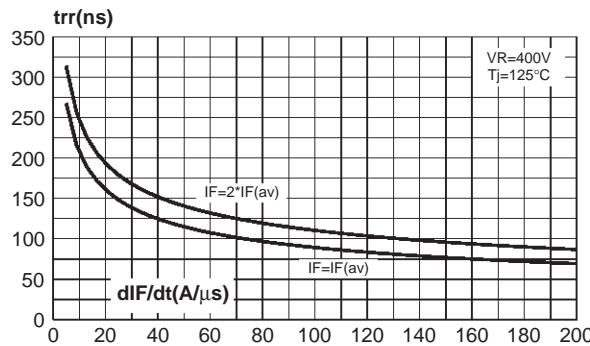
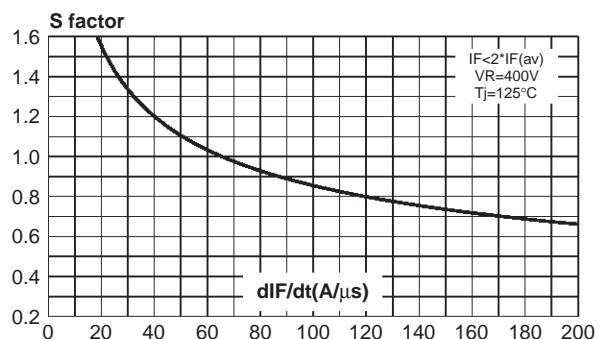
### DYNAMIC ELECTRICAL CHARACTERISTICS

#### TURN-OFF SWITCHING

| Symbol          | Parameter                        | Test conditions        |  |  | Min. | Typ. | Max. | Unit |
|-----------------|----------------------------------|------------------------|--|--|------|------|------|------|
| t <sub>rr</sub> |                                  | T <sub>j</sub> = 25°C  | I <sub>F</sub> =0.5A I <sub>R</sub> =1A I <sub>rr</sub> =0.25A<br>I <sub>F</sub> =1A dI <sub>F</sub> /dt= -50A/μs<br>V <sub>R</sub> =30V |  | 20   | 50   |      | ns   |
| I <sub>RM</sub> | Maximum reverse recovery current | T <sub>j</sub> = 125°C | I <sub>F</sub> =3A V <sub>R</sub> =400V<br>dI <sub>F</sub> /dt= -16A/μs<br>dI <sub>F</sub> /dt= -50A/μs                                  |  | 2.0  | 1.2  |      | A    |
| S factor        | Softness factor                  | T <sub>j</sub> = 125°C | V <sub>R</sub> =400V I <sub>F</sub> =3A<br>dI <sub>F</sub> /dt= -50A/μs  |  | 1.1  |      |      | -    |

#### TURN-ON SWITCHING

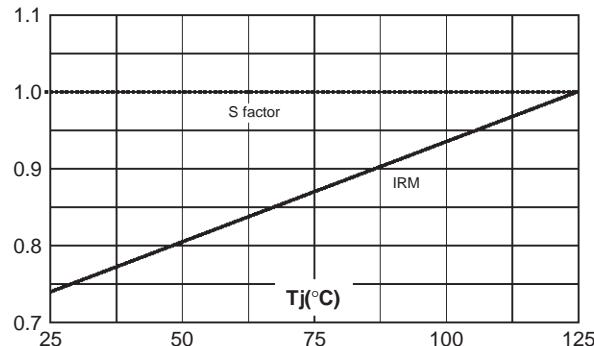
| Symbol          | Parameter             | Test conditions       |  |  | Min. | Typ. | Max. | Unit |
|-----------------|-----------------------|-----------------------|--|--|------|------|------|------|
| t <sub>fr</sub> | Forward recovery time | T <sub>j</sub> = 25°C | I <sub>F</sub> =3A dI <sub>F</sub> /dt = 16A/μs<br>Measured at 1.1 x V <sub>Fmax</sub> |  |      | 500  |      | ns   |
| V <sub>FP</sub> | Peak forward voltage  | T <sub>j</sub> = 25°C | I <sub>F</sub> =2A dI <sub>F</sub> /dt = 16A/μs  |  |      | 10   |      | V    |

**Fig. 1:** Conduction losses versus average current.**Fig. 2:** Forward voltage drop versus forward current (maximum values).**Fig. 3:** Relative variation of thermal transient impedance junction to ambient versus pulse duration (recommended pad layout).**Fig. 4:** Peak reverse recovery current versus dI<sub>F</sub>/dt (90% confidence).**Fig. 5:** Reverse recovery time versus dI<sub>F</sub>/dt (90% confidence).**Fig. 6:** Softness factor (tb/ta) versus dI<sub>F</sub>/dt (typical values).

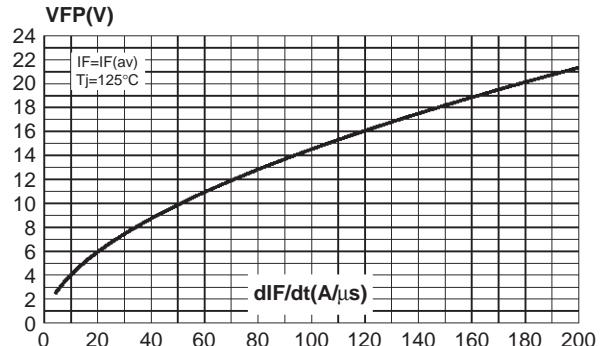
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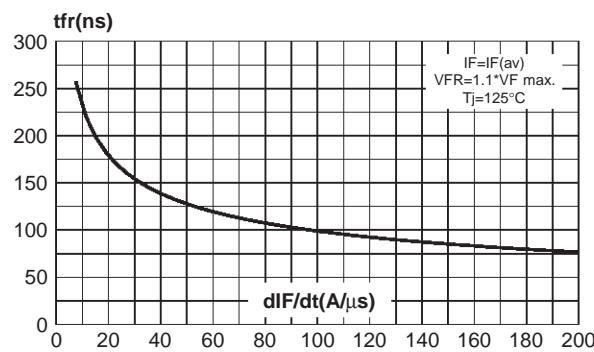
**Fig. 7:** Relative variation of dynamic parameters versus junction temperature (reference  $T_j=125^\circ\text{C}$ ).



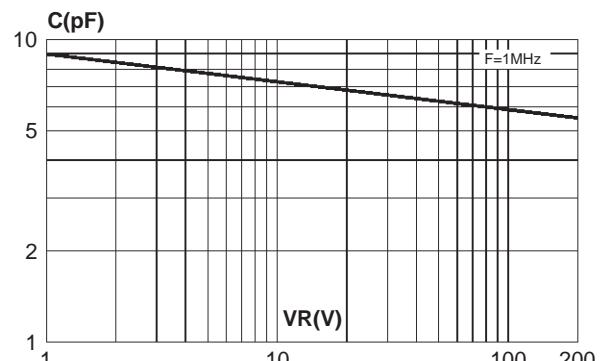
**Fig. 8:** Transient peak forward voltage versus  $dI_F/dt$  (90% confidence).



**Fig. 9:** Forward recovery time versus  $dI_F/dt$  (90% confidence).



**Fig. 10:** Junction capacitance versus reverse voltage applied (typical values).



**APPLICATION DATA**

The TURBOSWITCH™ is especially designed to provide the lowest overall power losses in any Freewheel Mode application (see fig. A) considering both the diode and the companion transistor, thus optimizing the overall performance in the end application.

The way of calculating the power losses is given below:

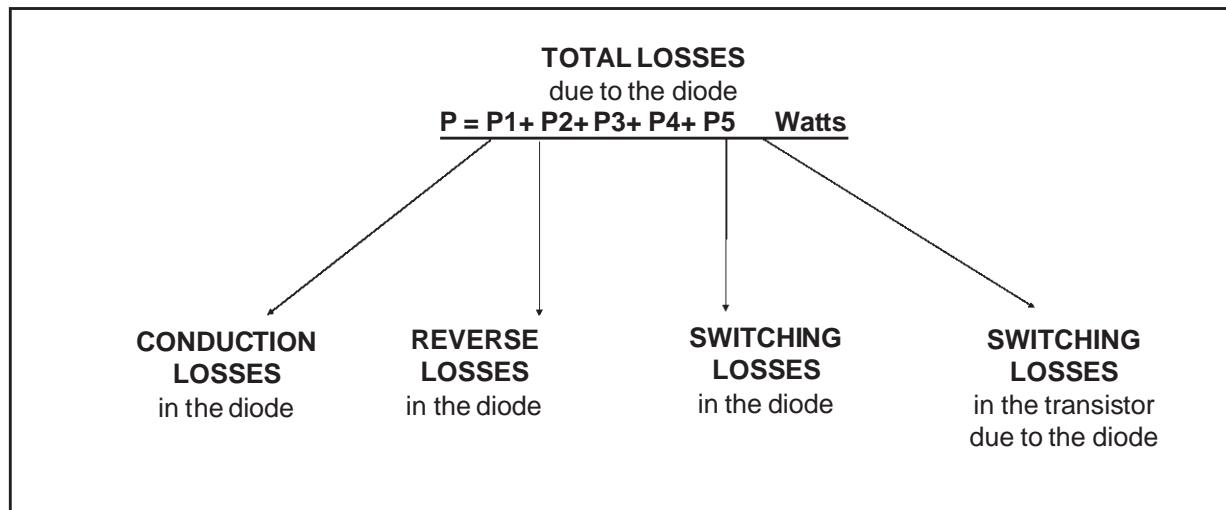
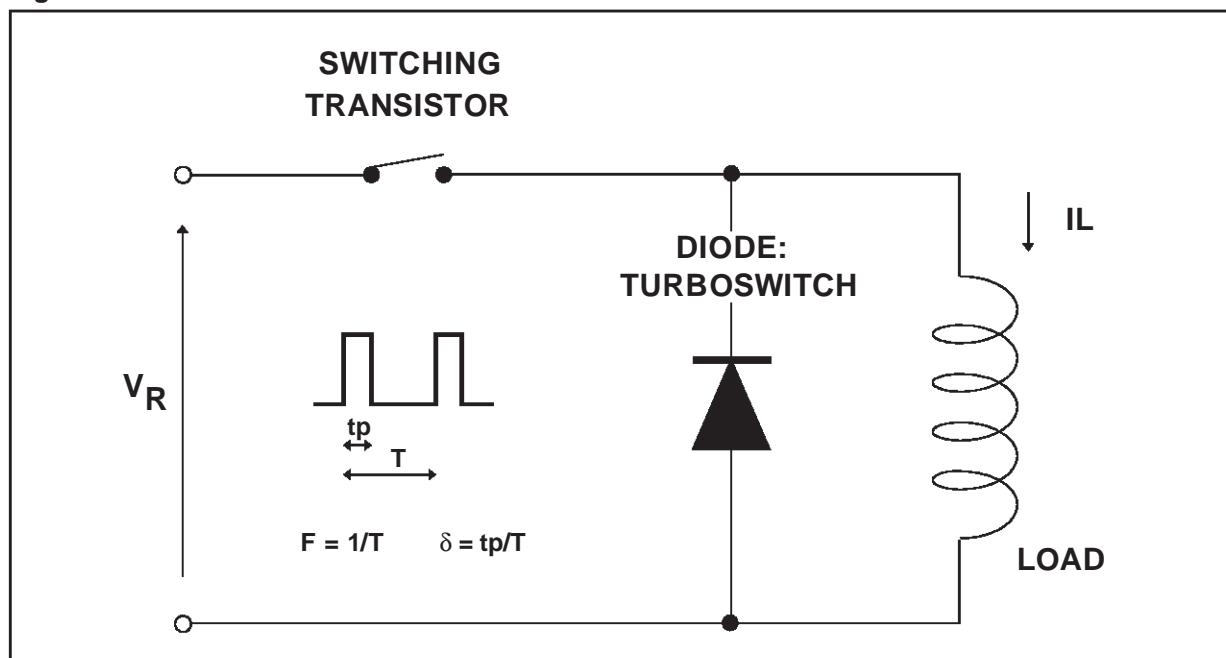


Fig. A : "FREEWHEEL" MODE



APPLICATION DATA (Cont'd)

Fig. B : STATIC CHARACTERISTICS

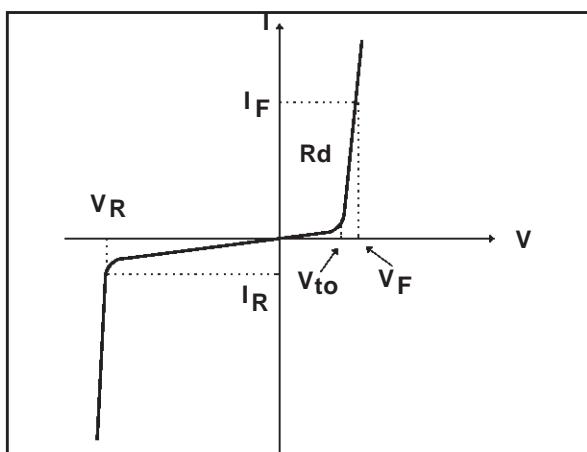
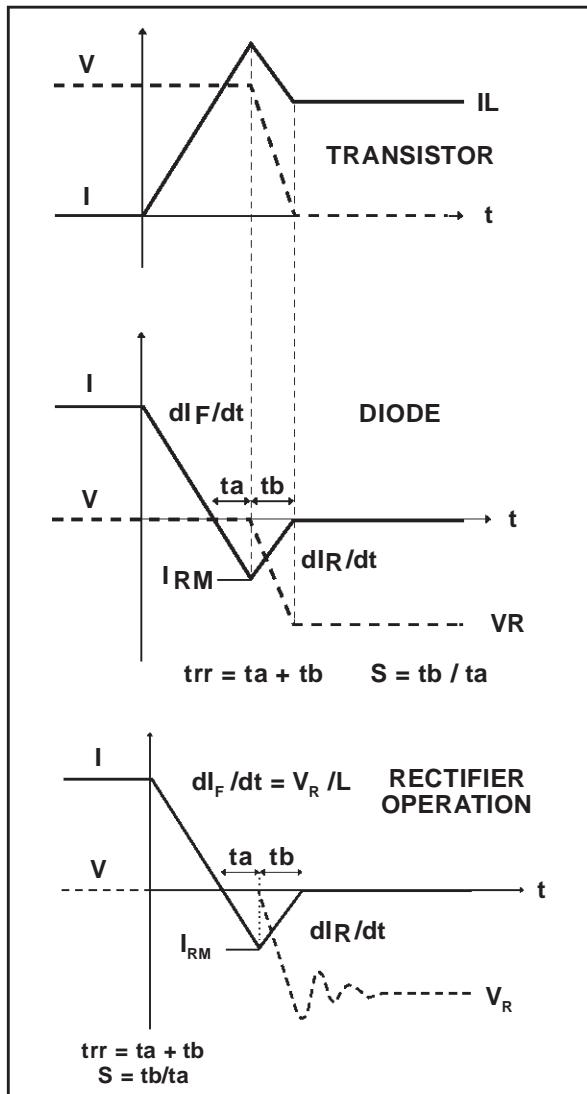


Fig. C : TURN-OFF CHARACTERISTICS



**Conduction losses :**

$$P1 = V_{to} \times I_{F(AV)} + R_d \times I_{F(RMS)}^2$$

**Reverse losses :**

$$P2 = V_R \times I_R \times (1 - \delta)$$

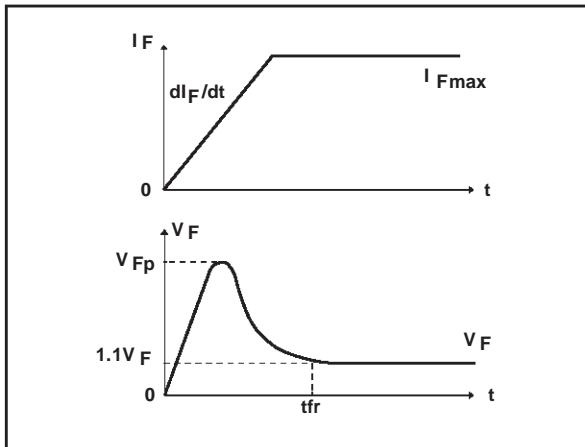
**Turn-on losses :**  
(in the transistor, due to the diode)

$$P5 = \frac{V_R \times I_{RM}^2 \times (3 + 2 \times S) \times F}{6 \times dI_F/dt} + \frac{V_R \times I_{RM} \times I_L \times (S + 2) \times F}{2 \times dI_F/dt}$$

**Turn-off losses (in the diode) :**

$$P3 = \frac{V_R \times I_{RM}^2 \times S \times F}{6 \times dI_F/dt}$$

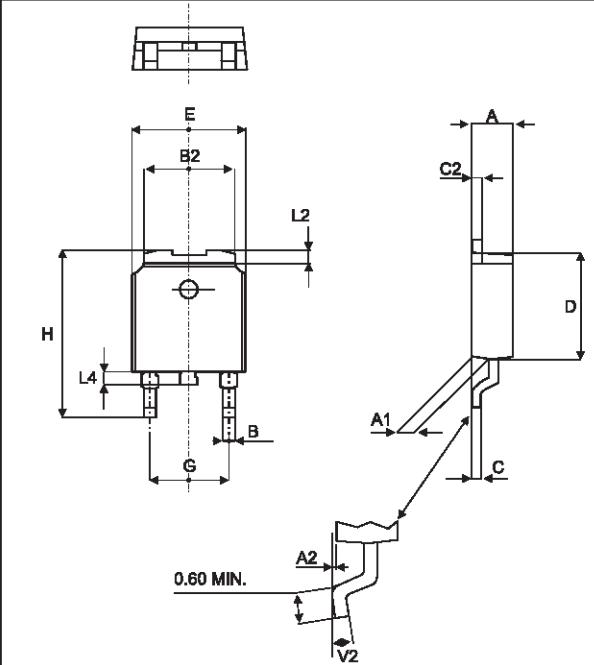
P3 and P5 are suitable for power MOSFET and IGBT

**APPLICATION DATA (Cont'd)****Fig. D : TURN-ON CHARACTERISTICS****Turn-on losses:**

$$P_4 = 0.4 (V_{FP} - V_F) \times I_{F\max} \times t_{fr} \times F$$

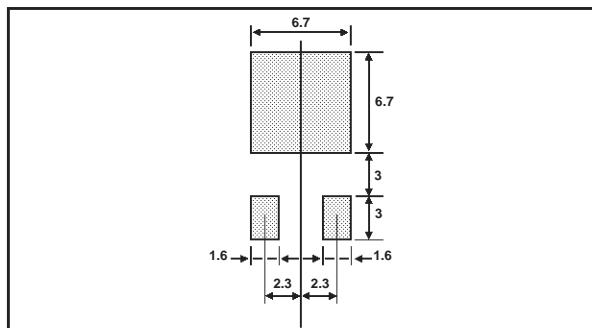
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### PACKAGE MECHANICAL DATA DPAK



| REF. | DIMENSIONS  |       |            |       |
|------|-------------|-------|------------|-------|
|      | Millimeters |       | Inches     |       |
|      | Min.        | Max.  | Min.       | Max.  |
| A    | 2.20        | 2.40  | 0.086      | 0.094 |
| A1   | 0.90        | 1.10  | 0.035      | 0.043 |
| A2   | 0.03        | 0.23  | 0.001      | 0.009 |
| B    | 0.64        | 0.90  | 0.025      | 0.035 |
| B2   | 5.20        | 5.40  | 0.204      | 0.212 |
| C    | 0.45        | 0.60  | 0.017      | 0.023 |
| C2   | 0.48        | 0.60  | 0.018      | 0.023 |
| D    | 6.00        | 6.20  | 0.236      | 0.244 |
| E    | 6.40        | 6.60  | 0.251      | 0.259 |
| G    | 4.40        | 4.60  | 0.173      | 0.181 |
| H    | 9.35        | 10.10 | 0.368      | 0.397 |
| L2   | 0.80 typ.   |       | 0.031 typ. |       |
| L4   | 0.60        | 1.00  | 0.023      | 0.039 |
| V2   | 0°          | 8°    | 0°         | 8°    |

### FOOTPRINT DIMENSIONS (in millimeters)



| Ordering type | Marking | Package | Weight | Base qty | Delivery mode |
|---------------|---------|---------|--------|----------|---------------|
| STTA306B      | A306    | DPAK    | 0.3 g. | 75       | Tube          |
| STTA306B-TR   | A306    | DPAK    | 0.3 g. | 2500     | Tape & reel   |

■ Epoxy meets UL94,V0

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